

Embedded Single Board Computer with 11th Generation Intel Xeon W-11000 Processors

3U CompactPCI Serial

- 11th Gen Intel Xeon W Processor (Tiger Lake)
- Up to 64 GB soldered DDR4-3200 ECC RAM
- 120 GB NVMe on-board storage
- Dual 10G Ethernet (optional)
- Board Management Controller, TPM 2.0
- Front I/O: 2× 1G Ethernet M12, 10Gbps USB-A & USB-C with DP Alt Mode
- Rear I/O: 1G Ethernet, PCIe, USB 10Gbps, SATA
- -40 °C to +70 °C operating temp. (system ambient)
- Long-term availability



Technical Data

CPU

- The following CPU types are supported:
 - Intel Xeon W-11865MRE, 8 cores, 16 threads, 2.6 GHz, 45 W, -40 °C to +100 °C
 - Intel Xeon W-11865MLE, 8 cores, 16 threads, 2.1 GHz, 35 W, -40 °C to +100 °C
 - Intel Xeon W-11555MRE, 6 cores, 12 threads, 2.6 GHz, 45 W, -40 °C to +100 °C
 - Intel Xeon W-11555MLE, 6 cores, 12 threads, 2.1 GHz, 35 W, -40 °C to +100 °C
 - Intel Xeon W-11155MRE, 4 cores, 8 threads, 2.4 GHz, 45 W, -40 °C to +100 °C
 - Intel Xeon W-11155MLE, 4 cores, 8 threads, 1.9 GHz, 35 W, -40 °C to +100 °C
 - Intel Xeon W-11865MLE, 8 cores, 16 threads, 1.5 GHz, 25 W, 0 °C to +100 °C
 - Intel Xeon W-11555MLE, 6 cores, 12 threads, 1.9 GHz, 25 W, 0 °C to +100 °C
 - Intel Xeon W-11155MLE, 4 cores, 8 threads, 1.8 GHz, 25 W, 0 °C to +100 °C
 - Other processor types are available on request

Memory

- System RAM: 64 GB max., soldered DDR4, ECC
- Non-volatile RAM (NVRAM): 64 kB FRAM

Mass Storage

- NVMe (soldered); 120 GB (standard)

Data Sheet



Graphics	Processor graphics
Interfaces	- This product includes interface options - Different front connectors - I/O expansion via add-on board - SATA 4 × SATA Revision 3.x, backplane - Video 1 × DisplayPort 1.4a, USB Type-C, for service - USB 1 × USB 3.2 Gen 2x1, Type-A, for service 1 × USB 3.2 Gen 2x1, Type-C, for service 4 × USB 3.2 Gen 2x1, backplane - Ethernet 2 × 10/100/1000BASE-T, M12, X-coded, receptacle 2 × 100/1000BASE-TX / 2.5/5/10GBASE-TX, M12, X-coded, receptacle 2 × 10/100/1000BASE-T, backplane - PCI Express 2 × PCIe 3.0, x8, backplane 1 × PCIe 3.0, x4, backplane 3 × PCIe 3.0, x4, backplane 2 × PCIe 3.0, x1, backplane - Serial 1 × RS232/RS422/RS485, isolated, D-Sub, 9-pin, plug 1 × USB-to-UART, USB Type-A - I2C 1 × backplane - LED - Status: board status (BMC) - Ethernet: link, activity - Hot-swap
Supervision and Management	- Board management controller - Temperature measurement - System watchdog (BMC) - Real-time clock, buffered by supercapacitor (up to 4 days) or battery (1 year) - Trusted Platform Module 2.0
Product Standard	CompactPCI Serial: CompactPCI Serial PICMG CPCI-S.0 Specification
Electrical Specifications	- Supply voltage: +12 V (9.5 V to 15.5 V) - Power consumption: 79 W max.
Mechanical Specifications	- Dimensions: 3U, 8 HP - Weight: 540 g - Cooling: Air cooling, forced convection, airflow 2.5 m/s
Product Compliance: Rail - Rolling Stock	- Compliance level: This product is prepared for use in EN 50155 systems. Some parameters are system-dependent and are specified on system level. - Operating temperature: -40 °C to +70 °C, +85 °C for 10 min (EN 50155:2021, class OT4, ST1)



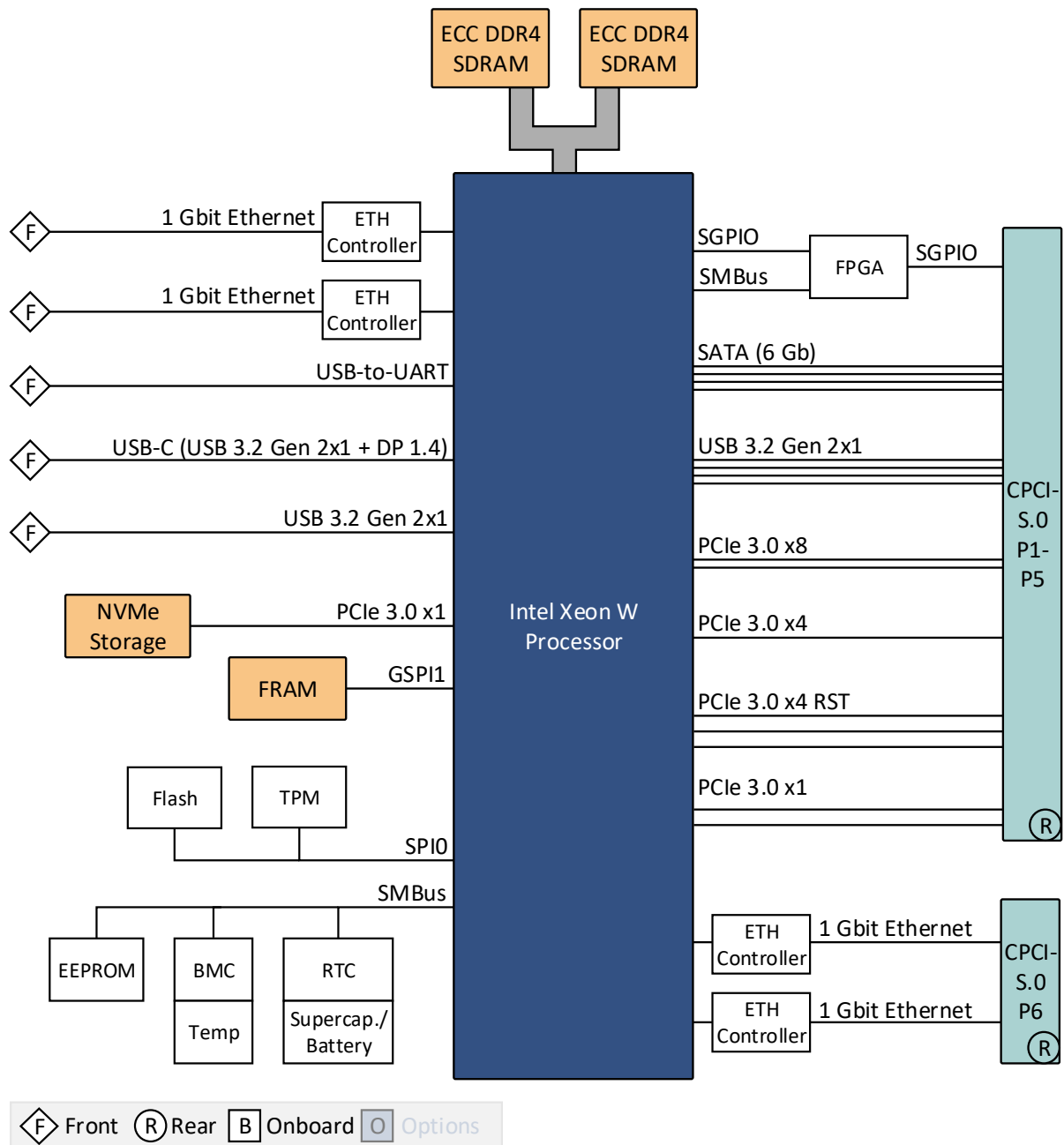
- Equipment location
 - EN 50155:2021, location 1, closed electrical operating area
 - EN 50155:2021, location 2, cabin and interiors
- Rapid temperature variations: EN 50155:2021, class H1, no requirements
- Storage temperature: -40 °C (EN 50155:2021) to +85 °C (EN 60068-2-2, Bb)
- Altitude: +3000 m max. (EN 50125-1:2014, class AX)
- Pollution degree: EN 50124-1:2017, class PD2
- Humidity: +55 °C and +25 °C, 100 % RH max. (EN 50155:2021)
- Shock: 30 ms @ 50 m/s² (EN 61373:2010/AC:2017-09, vehicle body, cat. 1, class B)
- Vibration: 10 min @ 2.02 m/s² (functional) and 5 h @ 11.44 m/s² (long-life) (EN 61373:2010/AC:2017-09, vehicle body, cat. 1, class B, double acceleration)
- Electrical safety
 - EN 50155:2021
 - EN 50153:2014 + A1:2017 + A2:2020
 - EN 50124-1:2017
 - EN ISO 13732-1:2008
- Fire protection: EN 45545-2:2020, EL9, HL3
- EMC emission
 - EN 50121-3-2:2016 + A1:2019
 - Regelung Nr. EMV 06 :2019-05-09 (2.0), Anhang E: Messung an Geräten, Schutzklasse S1
 - Regelwerk 50.02.01 :2021-12-01, 12.3.2. EMV - Funk, prequalified according to electronic equipment tests defined by Deutsche Bahn EMV 06 standard, class S1, for risk minimization in finished vehicle test
- EMC immunity: EN 50121-3-2:2016 + A1:2019
- Protective coatings: EN 50155:2021, class PC2 (Any PCB protected on both sides)
- Useful life: 20 years (EN 50155:2021, class L4)

Reliability	■ MTBF: 240 531 h predicted @ 40 °C according to IEC/TR 62380 (RDF 2000)
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BIOS/Boot Loader	■ AMI Aptio UEFI Firmware
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Software Support	■ Linux ■ Certified for Red Hat Enterprise Linux 9.2 - 9.x ■ Tested with: Ubuntu 22.04 LTS ■ Windows ■ Windows 10 IoT Enterprise 64-bit ■ Not all functions are supported ■ See the product User Manual for details on software support: www.duagon.com/products/g28m/#doc ■ See section Software on the product web page for available packages: www.duagon.com/products/g28m/#downl ■ See also Application Note <i>Recommendations for a Robust Software Setup</i>
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Diagram



Ordering Information

Standard Models

02G028M00	3U CPCI Serial, 8 HP, Intel Xeon W-11865MRE, 8 cores, 16 threads, 2.1 GHz, 35 W TDP, 64 GB DDR4 (ECC) RAM, 120 GB NVMe, 2x 1G Ethernet M12, 1x USB 3.2 Gen 2x1, 1x USB 3.2 Gen 2x1 and DisplayPort over USB-C, 1x console redirection via USB, -40 °C to +70 °C, conformal coating
02G028M01	3U CPCI Serial, 8 HP, Intel Xeon W-11865MRE, 8 cores, 16 threads, 2.1 GHz, 35 W TDP, 64 GB DDR4 (ECC) RAM, 120 GB NVMe, 2x 10G Ethernet M12, 2x 1G Ethernet M12, 1x USB 3.2 Gen 2x1, 1x USB 3.2 Gen 2x1 and DisplayPort over USB-C, 1x console redirection via USB, 1x RS232 isolated and 1x RS422/485 isolated on shared 9-pin D-Sub, -40 °C to +70 °C, conformal coating

► **Contact duagon** for availability and lead times for product models not listed above.